



THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 10/620,468
Confirmation No. 8630
Filing Date July 15, 2003
Inventor Dinesh Chopra
Assignee Micron Technology, Inc.
Group Art Unit 2822
Examiner T. Tran
Customer No. 021567
Attorney's Docket No. MI22-2345
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and
Integrated Circuits Formed Thereby

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Reference -See Attached Form PTO-1449


In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 26 Feb 2007


By: _____


James E. Lake
Reg. No. 44,854

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Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY. DOCKET NO. M122-2345		SERIAL NO. 10/620,468	
 <p>STATE OF ART CITED BY APPLICANT (Use several sheets if necessary)</p>				APPLICANT: Dinesh Chopra et al.			
				FILING DATE July 15, 2003		GROUP 2822	
U.S. PATENT DOCUMENTS							
*Examiner's Initials	AA	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
FOREIGN PATENT DOCUMENTS							
		Document Number	Date	Country	Class	Subclass	Translation
	AJ	JP 6-69270	06/1994	Japan			Yes No
	AK						
	AL						
OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)							
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	AN						
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